

Description

The AP70N03NF uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = 30V I_{D} = 70A$

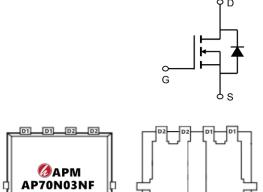
 $R_{DS(ON)} < 5.5 m\Omega$ @ $V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply





Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP70N03NF	PDFN5*6-8L	AP70N03NF XXX YYYY	5000

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	Drain-Source Voltage 30	
Vgs	Gate-Source Voltage	±20	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	70	Α
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	51	Α
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	15	Α
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	12	Α
Ірм	Pulsed Drain Current ²	160	Α
EAS	Single Pulse Avalanche Energy ³	115.2	mJ
las	Avalanche Current	48	Α
P _D @T _C =25℃	Total Power Dissipation ⁴	59	W
P _D @T _A =25°C	Total Power Dissipation⁴	2	W
Тѕтс	Storage Temperature Range	-55 to 150	℃
TJ	Operating Junction Temperature Range	-55 to 150	°C
Reja	Thermal Resistance Junction-Ambient ¹	62	°C/W
Rejc	Thermal Resistance Junction-Case ¹	2.1	°C/W





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V	
∆BVDSS/∆TJ	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.028		V/°C	
DDC(ON)	Statia Duain Sauras On Basistanas	V _{GS} =10V , I _D =30A		3.5	5.5	0	
RDS(ON)	S(ON) Static Drain-Source On-Resistance V _{GS} =4.5V , I _D =15A			6.5	8.5	mΩ	
VGS(th)	Gate Threshold Voltage	V V I 050 A	1.0	1.6	2.5	V	
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-6.16		mV/°C	
IDOO	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	uA	
IDSS		V _{DS} =24V , V _{GS} =0V , T _J =55°C			5		
IGSS	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		22		S	
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.7	3.4	Ω	
Qg	Total Gate Charge (4.5V)			20			
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		7.6		nC	
Q _{gd}	Gate-Drain Charge			7.2			
Td(on)	Turn-On Delay Time			7.8			
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω		15			
Td(off)	Turn-Off Delay Time	I _D =15A		37.3		ns	
T _f	Fall Time			10.6			
Ciss	Input Capacitance			2295			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		267		pF	
Crss	Reverse Transfer Capacitance	, , ,		210			
Is	Continuous Source Current ^{1,5}				80	Α	
ISM	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			160	Α	
VSD	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1	V	
t _{rr}	Reverse Recovery Time	, , , , , , , , , , , , , , , , , , , ,		14		nS	
Qrr	Reverse Recovery Charge	IF=30A , dl/dt=100A/µs ,Tյ=25°C		5		nC	

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2. The data tested by pulsed, pulse width. The EAS data shows Max. rating.
- 3.The test cond \leq 300us , duty cycle ition is $V_{DD=25} \leq V,V$ 2%GS =10V,L=0.1mH,Ias=53.8A
- 4.The power dissipation is limited by 175 $^{\circ}$ C junction temperature
- 5. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



Typical Characteristics

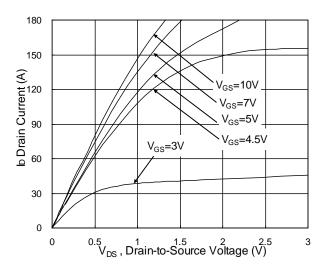


Fig.1 Typical Output Characteristics

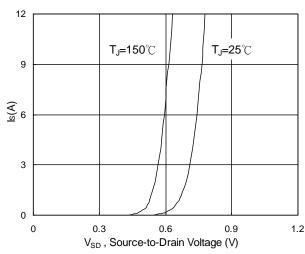
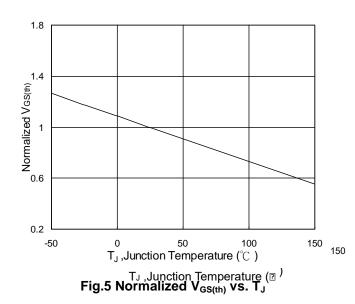


Fig.3 Forward Characteristics of Reverse



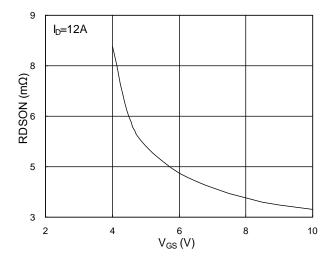


Fig.2 On-Resistance vs. G-S Voltage

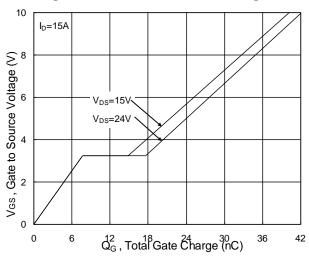
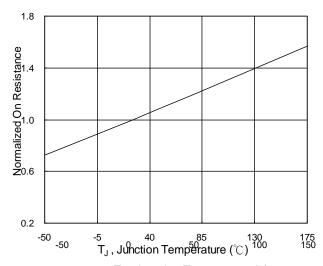


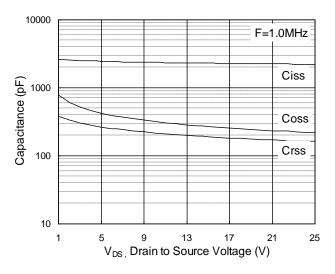
Fig.4 Gate-Charge Characteristics



 T_J , Junction Temperature (2) Fig.6 Normalized R_{DSON} vs. T_J







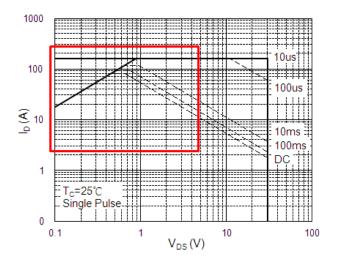


Fig.7 Capacitance

Fig.8 Safe Operating Area

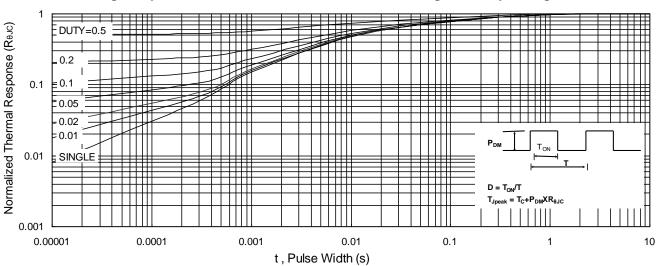


Fig.9 Normalized Maximum Transient Thermal Impedance

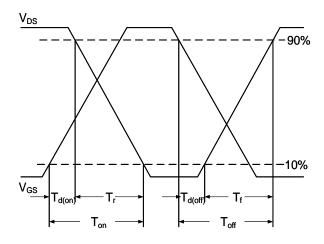


Fig.10 Switching Time Waveform

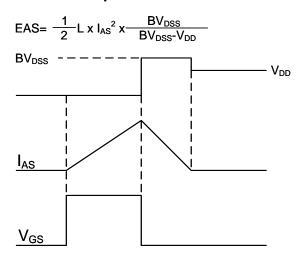
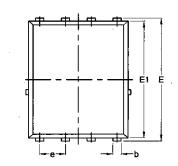
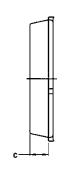


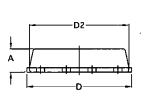
Fig.11 Unclamped Inductive Switching Waveform

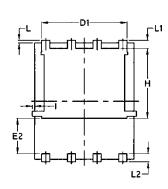


Package Mechanical Data-DFN5*6-8L-JQ Single









	Common				
Symbol	mm		Inch		
	Mim	Max	Min	Max	
Α	1.03	1.17	0.0406	0.0461	
b	0.34	0.48	0.0134	0.0189	
С	0.824	0.0970	0.0324	0.082	
D	4.80	5.40	0.1890	0.2126	
D1	4.11	4.31	0.1618	0.1697	
D2	4.80	5.00	0.1890	0.1969	
E	5.95	6.15	0.2343	0.2421	
E1	5.65	5.85	0.2224	0.2303	
E2	1.60	/	0.0630	/	
е	1.27 BSC		0.05 BSC		
L	0.05	0.25	0.0020	0.0098	
L1	0.38	0.50	0.0150	0.0197	
L2	0.38	0.50	0.0150	0.0197	
Н	3.30	3.50	0.1299	0.1378	
I	/	0.18	/	0.0070	



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AP70N03NF

30V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.0	2019/8/1	Initial release

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Test Report For 30PCS (30pcs 典型測試報告)

